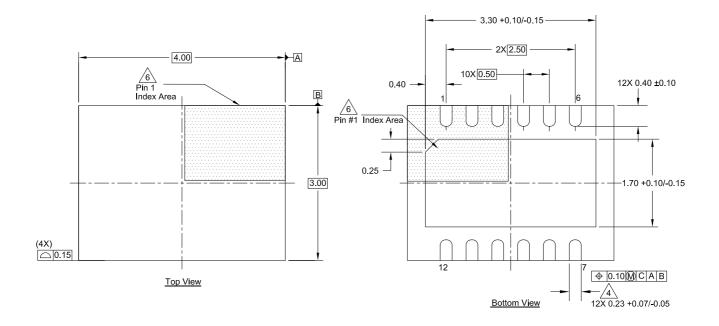
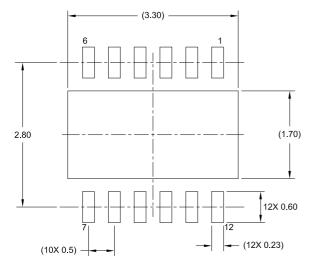
Plastic Packages for Integrated Circuits

Package Outline Drawing

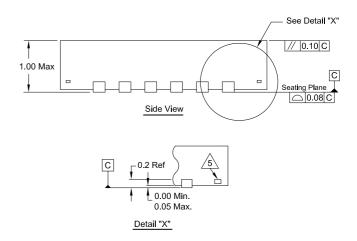
L12.4x3

12 Lead Dual Flat No-Lead Plastic Package Rev 4, 4/2021





Typical Recommended Land Pattern



Notes:

- Dimensions are in millimeters.
 Dimensions in () for Reference Only.
- 2. Dimensioning and tolerancing conform to ASME Y14.5m-1994.
- 3. Unless otherwise specified, tolerance: Decimal ±0.05

Tiebar shown (if present) is a non-functional feature and may be located on any of 4 sides (or ends).

6. The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 indentifier may be either a mold or mark feature.

7. Compliant to Jedec MO-229 V4030D-4 issue E.

